

15A, 45V Low V_F Trench Schottky Surface Mount Rectifier

FEATURES

- Patented Trench Schottky technology
- Excellent high temperature stability
- Low forward voltage
- Lower power loss/ high efficiency
- High forward surge capability
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converter

MECHANICAL DATA

• Case: SMPC4.0

Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

• Meet JESD 201 class 2 whisker test

Polarity: Indicated by cathode band

• Weight: 0.095g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	15	Α	
V_{RRM}	45	V	
I _{FSM}	200	Α	
T _{J MAX}	150	°C	
Package	SMPC4.0		
Configuration	Single die		

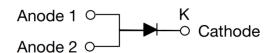








SMPC4.0



PARAMETER	SYMBOL	TSPB15U45S	UNIT
Marking code on the device		B15U45	
Repetitive peak reverse voltage	V_{RRM}	45	V
Reverse voltage, total rms value	$V_{R(RMS)}$	31	V
Forward current	I _F	15	А
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	200	А
Junction temperature	T_J	- 55 to +150	°C
Storage temperature	T _{STG}	- 55 to +150	°C



Taiwan Semiconductor

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	8	°C/W	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	I _F = 15A, T _J = 25°C	V _F	0.48	0.56	V
	I _F = 15A, T _J = 125°C		0.39	0.45	V
Reverse current @ rated V _R ⁽²⁾	T _J = 25°C	I _R	-	300	μA
	T _J = 125°C		-	150	mA

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
TSPB15U45S	SMPC4.0	6,000 / Tape & Reel	



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

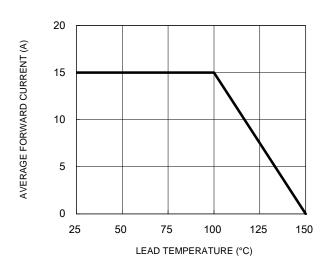


Fig.3 Typical Reverse Characteristics

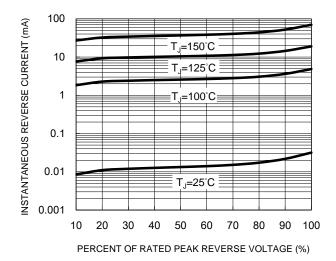


Fig.2 Typical Junction Capacitance

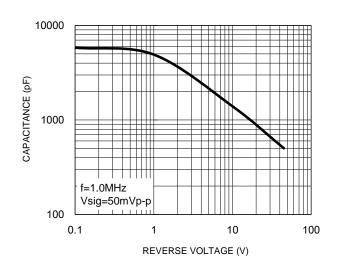
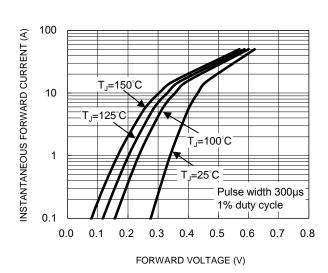


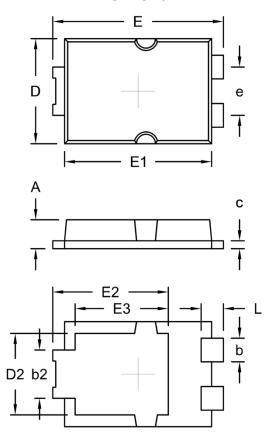
Fig.4 Typical Forward Characteristics





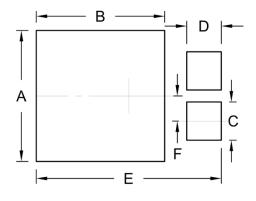
PACKAGE OUTLINE DIMENSIONS

SMPC4.0



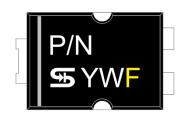
DIM	OIM. Unit (mm) Min. Max.		Unit (inch)	
DIWI.			Min.	Max.	
Α	1.00	1.20	0.039	0.047	
b	0.75	1.05	0.030	0.041	
b2	1.69	1.99	0.067	0.078	
С	0.20	0.40	0.008	0.016	
D	3.95	4.05	0.156	0.159	
D2	2.95	3.25	0.116	0.128	
E	6.35	6.65	0.250	0.262	
E1	5.55	5.65	0.219	0.222	
E2	4.25	4.55	0.167	0.179	
E3	3.40	3.70	0.134	0.146	
е	1.69	1.99	0.067	0.078	
L	0.70	1.00	0.028	0.039	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	4.80	0.189
В	4.72	0.186
С	1.40	0.055
D	1.27	0.050
E	6.80	0.268
F	0.92	0.036

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code





Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.